
**Plastics — Determination of thermal
conductivity and thermal diffusivity —**

**Part 2:
Transient plane heat source (hot disc)
method**

*Plastiques — Détermination de la conductivité thermique et de la
diffusivité thermique —*

Partie 2: Méthode de la source plane transitoire (disque chaud)



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Contents

	Page
Foreword.....	iv
Introduction.....	vi
1 Scope.....	1
2 Normative references.....	1
3 Terms and definitions.....	1
4 Principle.....	3
5 Apparatus.....	3
6 Test specimens.....	5
6.1 Bulk specimens.....	5
6.2 Anisotropic bulk specimens.....	6
6.3 Slab specimens.....	6
6.4 Thin-film specimens.....	7
7 Procedure.....	7
8 Calculation of thermal properties.....	9
8.1 Bulk specimens.....	9
8.2 Anisotropic bulk specimens.....	12
8.3 Slab specimens.....	13
8.4 Thin-film specimens.....	14
8.5 Low thermally conducting specimens.....	15
8.5.1 Introductory remarks.....	15
8.5.2 Low thermally conducting bulk specimens.....	15
8.5.3 Low thermally conducting anisotropic bulk specimens.....	17
8.5.4 Low thermally conducting thin-film specimen.....	17
9 Calibration and verification.....	17
9.1 Calibration of apparatus.....	17
9.2 Verification of apparatus.....	18
10 Precision and bias.....	18
11 Test report.....	19
Bibliography.....	20

Foreword

ISO (the International Organization for Standardization) is a worldwide federation of national standards bodies (ISO member bodies). The work of preparing International Standards is normally carried out through ISO technical committees. Each member body interested in a subject for which a technical committee has been established has the right to be represented on that committee. International organizations, governmental and non-governmental, in liaison with ISO, also take part in the work. ISO collaborates closely with the International Electrotechnical Commission (IEC) on all matters of electrotechnical standardization.

The procedures used to develop this document and those intended for its further maintenance are described in the ISO/IEC Directives, Part 1. In particular the different approval criteria needed for the different types of ISO documents should be noted. This document was drafted in accordance with the editorial rules of the ISO/IEC Directives, Part 2 (see www.iso.org/directives).

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For an explanation on the meaning of ISO specific terms and expressions related to conformity assessment, as well as information about ISO's adherence to the WTO principles in the Technical Barriers to Trade (TBT) see the following URL: [Foreword - Supplementary information](#)

The committee responsible for this document is ISO/TC 61, *Plastics*, Subcommittee SC 5, *Physical-chemical properties*.

This second edition cancels and replaces the first edition (ISO 22007-2:2008), which has been technically revised.

The main changes are the following:

- a) Values of thermal conductivity in scope revised;
- b) Sensitivity coefficient revised ([3.3](#));
- c) Thickness range for thin-film specimens changed ([6.4](#));
- d) Low thermally conducting specimens specified ([8.5](#));
- e) Precision and bias adapted; ([10.2](#));
- f) Bibliography extended;
- g) Normative references updated and standard editorial revised.

ISO 22007 consists of the following parts, under the general title *Plastics — Determination of thermal conductivity and thermal diffusivity*:

- *Part 1: General principles*
- *Part 2: Transient plane heat source (hot disc) method*
- *Part 3: Temperature wave analysis method*
- *Part 4: Laser flash method*
- *Part 5: Results of interlaboratory testing of poly(methyl methacrylate) samples* [Technical Report]

— *Part 6: Comparative method for low thermal conductivities using a temperature-modulation technique*

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Introduction

A significant increase in the development and application of new and improved materials for broad ranges of physical, chemical, biological, and medical applications has necessitated better performance data from methods of measurement of thermal-transport properties. The introduction of alternative methods that are relatively simple, fast, and of good precision would be of great benefit to the scientific and engineering communities. [1]

A number of measurement techniques described as transient methods have been developed and several have been commercialized. These are being widely used and are suitable for testing many types of material. In some cases, they can be used to measure several properties separately or simultaneously. [2],[3]

A further advantage of some of these methods is that it has become possible to measure the true bulk properties of a material. This feature stems from the possibility of eliminating the influence of the thermal contact resistance (see 8.1.1) that is present at the interface between the probe and the specimen surfaces. [1],[3],[4],[5],[6]

Plastics — Determination of thermal conductivity and thermal diffusivity —

Part 2:

Transient plane heat source (hot disc) method

1 Scope

This part of ISO 22007 specifies a method for the determination of the thermal conductivity and thermal diffusivity, and hence the specific heat capacity per unit volume of plastics. The experimental arrangement can be designed to match different specimen sizes. Measurements can be made in gaseous and vacuum environments at a range of temperatures and pressures.

This method is suitable for testing homogeneous and isotropic materials, as well as anisotropic materials with a uniaxial structure. The homogeneity of the material extends throughout the specimen and no thermal barriers (except those next to the probe) are present within a range defined by the probing depth(s) (see 3.2 below).

The method is suitable for materials having values of thermal conductivity, λ , in the approximate range $0,010 \text{ W}\cdot\text{m}^{-1}\cdot\text{K}^{-1} < \lambda < 500 \text{ W}\cdot\text{m}^{-1}\cdot\text{K}^{-1}$, values of thermal diffusivity, α , in the range $5 \times 10^{-8} \text{ m}^2\cdot\text{s}^{-1} < \alpha < 10^{-4} \text{ m}^2\cdot\text{s}^{-1}$, and for temperatures, T , in the approximate range $50 \text{ K} < T < 1\,000 \text{ K}$.

NOTE 1 The specific heat capacity per unit volume, C , can be obtained by dividing the thermal conductivity, λ , by the thermal diffusivity, α , i.e. $C = \lambda/\alpha$, and is in the approximate range $0,005 \text{ MJ}\cdot\text{m}^{-3}\cdot\text{K}^{-1} < C < 5 \text{ MJ}\cdot\text{m}^{-3}\cdot\text{K}^{-1}$. It is also referred to as the volumetric heat capacity.

NOTE 2 If the intention is to determine the thermal resistance or the apparent thermal conductivity in the through-thickness direction of an inhomogeneous product (for instance a fabricated panel) or an inhomogeneous slab of a material, reference is made to ISO 8301, ISO 8302, and ISO 472.

The thermal-transport properties of liquids can also be determined, provided care is taken to minimize thermal convection.

2 Normative references

The following documents, in whole or in part, are normatively referenced in this document and are indispensable for its application. For dated references, only the cited edition applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

ISO 22007-1, *Plastics — Determination of thermal conductivity and thermal diffusivity — Part 1: General principles*

3 Terms and definitions

For the purposes of this document, the terms and definitions given in ISO 22007-1 and the following apply.

3.1

penetration depth

Δp_{pen}

measure of how far into the specimen, in the direction of heat flow, a heat wave has travelled

Note 1 to entry: For this method, the penetration depth is given by

$$\Delta p_{\text{pen}} = \kappa \sqrt{\alpha \cdot t_{\text{tot}}}$$

where

t_{tot} is the total measurement time for the transient recording;

α is the thermal diffusivity of the specimen material;

κ is a constant dependent on the sensitivity of the temperature recordings.

Note 2 to entry: It is expressed in metres (m).

3.2 probing depth

Δp_{prob}

measure of how far into the specimen, in the direction of heat flow, a heat wave has travelled during the time window used for calculation

Note 1 to entry: The probing depth is given by

$$\Delta p_{\text{prob}} = \kappa \sqrt{\alpha \cdot t_{\text{max}}}$$

where

t_{max} is the maximum time of the time window used for calculating the thermal-transport properties.

Note 2 to entry: It is expressed in metres (m).

Note 3 to entry: A typical value in hot disc measurements is $\kappa = 2$, which is assumed throughout this part of ISO 22007.

3.3 sensitivity coefficient

β_q

coefficient defined by the formula

$$\beta_q = q \frac{\partial [\Delta T(t)]}{\partial q}$$

where

q is the thermal conductivity, λ , the thermal diffusivity, α , or the volumetric specific heat capacity, C ;

$\Delta T(t)$ is the mean temperature increase of the probe.

Note 1 to entry: Different sensitivity coefficients are defined for thermal conductivity, thermal diffusivity, and specific heat per unit volume.^[2]

Note 2 to entry: To define the time window that is used to determine both the thermal conductivity and diffusivity from one single experiment, the theory of sensitivity coefficients is used. Through this theory, which deals with a large number of experiments and considers the constants, q , as variables, it has been established that

$$0,30 < t_{\text{max}} \cdot \alpha / r^2 < 1,0$$

where r is the mean radius of the outermost spiral of the probe.

Assuming $\kappa = 2$, this expression can be rewritten as

$$1,1r < \Delta p_{\text{prob}} < 2,0r$$

4 Principle

A specimen containing an embedded hot disc probe of negligible heat capacity is allowed to equilibrate at a given temperature. A heat pulse in the form of a stepwise function is produced by an electrical current through the probe to generate a dynamic temperature field within the specimen. The increase in the temperature of the probe is measured as a function of time. The probe operates as a temperature sensor unified with a heat source (i.e. a self-heated sensor). The response is then analysed in accordance with the model developed for the specific probe and the assumed boundary conditions.

5 Apparatus

5.1 A schematic diagram of the apparatus is shown in [Figure 1](#).

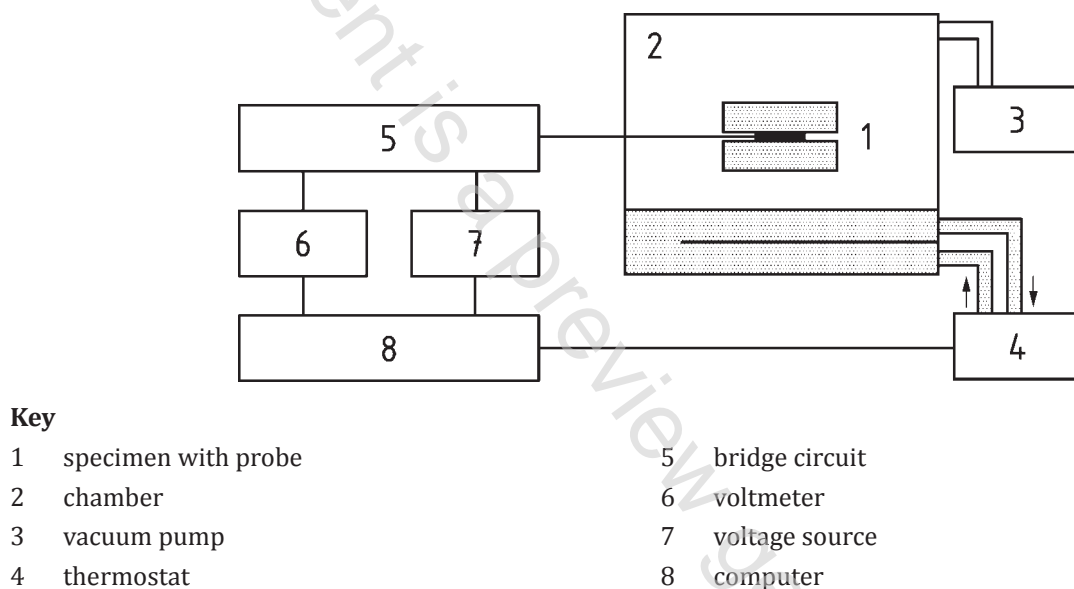


Figure 1 — Basic layout of the apparatus

5.2 A typical hot disc probe is shown in [Figure 2](#). Convenient probes can be designed with diameters from 2 mm to 200 mm, depending on the specimen size and the thermal-transport properties of the material to be tested. The probe is constructed as a bifilar spiral etched out of a $(10 \pm 2) \mu\text{m}$ thick metal foil and covered on both sides by thin (from $7 \mu\text{m}$ to $100 \mu\text{m}$) insulating film. It is recommended that nickel or molybdenum be used as the heater/temperature-sensing metal foil due to their relatively high temperature coefficient of electrical resistivity and stability over a wide temperature range. It is recommended that polyimide, mica, aluminium nitride, or aluminium oxide be used as the insulating film, depending on the ultimate temperature of use. The arms of the bifilar spiral forming an essentially circular probe shall have a width of $(0,20 \pm 0,03) \text{ mm}$ for probes with an overall diameter of 15 mm or less and a width of $(0,35 \pm 0,05) \text{ mm}$ for probes of larger diameter. The distance between the edges of the arms shall be the same as the width of the arms.